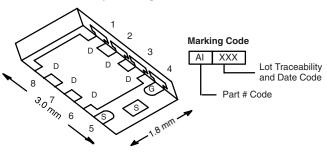


RoHS COMPLIANT

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.0145 at V _{GS} = 10 V	12	9.5 nC		
	0.0185 at V _{GS} = 4.5 V	12	9.5 110		





PowerPAK ChipFET Single

Ordering Information: Si5418DU-T1-GE3 (Lead (Pb)-free and Halogen-free)

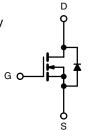
ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK® ChipFET[®] Package
 - Small Footprint Area
 - Low On-Resistance
 - Thin 0.8 mm Profile

APPLICATIONS

- · Load Switch, PA Switch, and Battery Switch for Portable Applications
- DC-DC Synchronous Rectification



N-Channel MOSFET

Symbol Limit Unit 30 VDS V ± 20 VGS

Gate-Source Voltage	V _{GS}	± 20	v		
	T _C = 25 °C		12 ^a		
Continuous Drain Current (T $_{1}$ = 150 °C)	T _C = 70 °C	I _D	12 ^a		
	T _A = 25 °C		11.6 ^{b, c}		
	T _A = 70 °C		9.3 ^{b, c}	А	
Pulsed Drain Current	Pulsed Drain Current				
Continuous Source-Drain Diode Current	T _C = 25 °C	le.	12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	2.6 ^{b, c}		
	T _C = 25 °C	PD	31		
Maximum Power Dissipation	T _C = 70 °C		20	W	
Maximum Fower Dissipation	T _A = 25 °C	۰D	3.1 ^{b, c}	vv	
	T _A = 70 °C		2 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) ^{d, e}		260	C		

THEDMAL DESIGTANCE DATINGS

Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	34	40	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3	4	C/VV		

Notes:

a. Package limited.

Parameter

Drain-Source Voltage

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 90 °C/W.



Vishay Siliconix

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		40		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \ \mu A$		- 7		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	IDSS	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	20			Α
	P	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.7 \text{ A}$		0.012	0.0145	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 6.9 \text{ A}$		0.015	0.0185	Ω
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 7.7 \text{ A}$		31		S
Dynamic ^b						
Input Capacitance	C _{iss}			1350		
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		190		pF
Reverse Transfer Capacitance	C _{rss}			80		
Total Gate Charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 11.6 A		20	30	nC
				9.5	15	
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 11.6 A		4.5		
Gate-Drain Charge	Q _{gd}			2.7		
Gate Resistance	R _g	f = 1 MHz		3.5		Ω
Turn-On Delay Time	t _{d(on)}			20	30	ns
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.6 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 9.3$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 Ω		20	30	
Fall Time	t _f			10	15	
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.6 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 9.3 A, V_{GEN} = 10 V, R_g = 1 Ω		20	30	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	۱ _S	$T_{C} = 25 \ ^{\circ}C$			12	٨
Pulse Diode Forward Current	I _{SM}				40	A
Body Diode Voltage	V _{SD}	$I_{S} = 9.3 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			25	40	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 9.3 A, dI/dt = 100 A/μs, T _J = 25 °C		19	30	nC
Reverse Recovery Fall Time	t _a	$r_F = 9.3 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}, r_J = 25 \text{ °C}$		14		
Reverse Recovery Rise Time	t _b			11		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



10

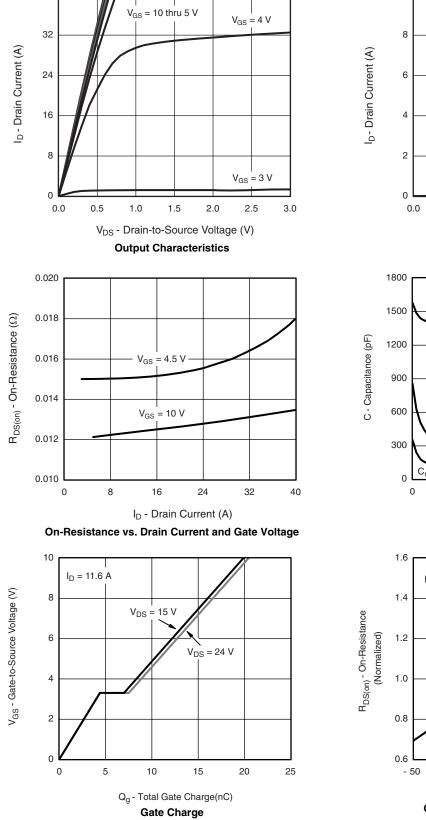


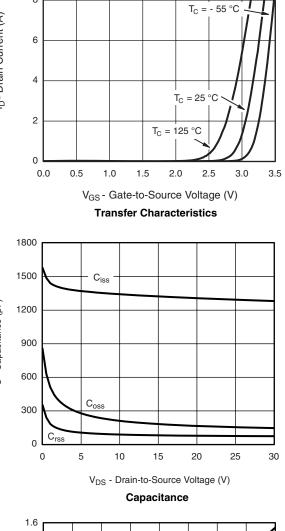
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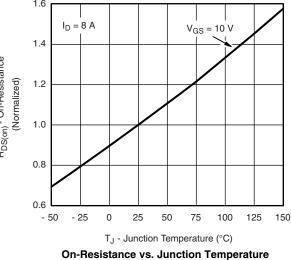
Si5418DU

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





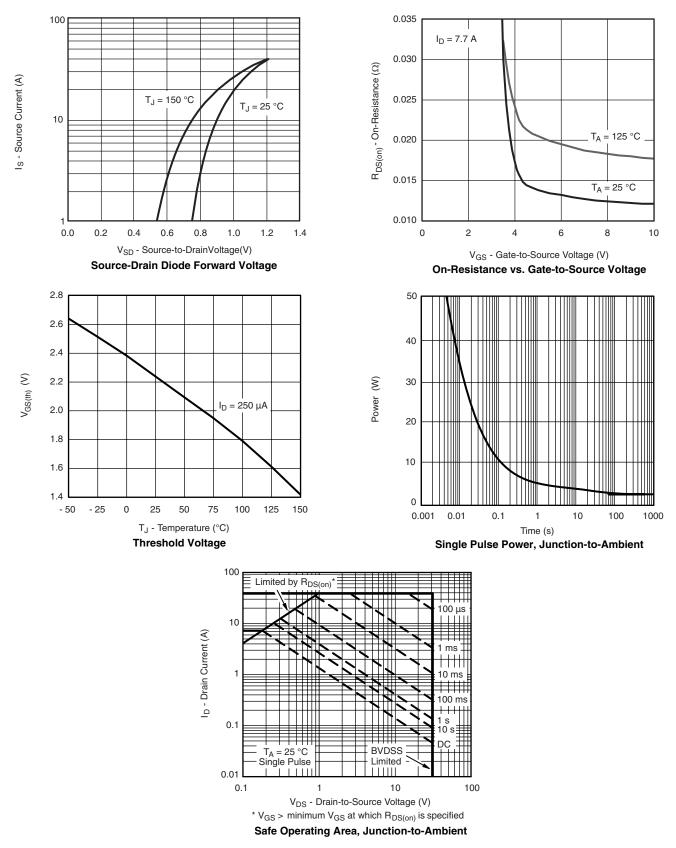


Document Number: 69822 S-81448-Rev. B, 23-Jun-08



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

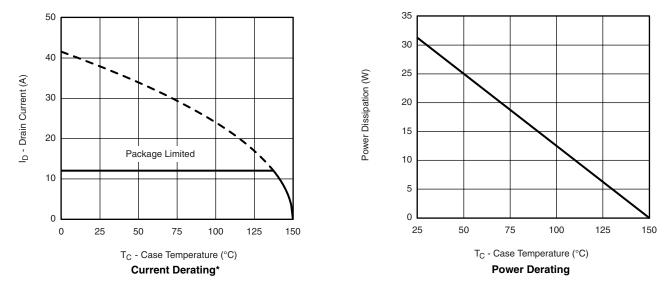






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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

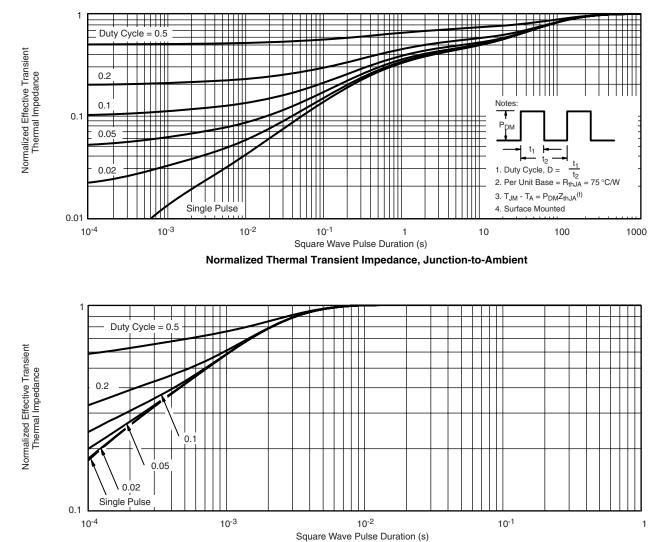


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



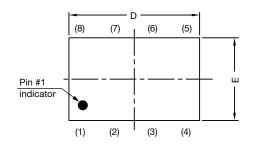
Normalized Thermal Transient Impedance, Junction-to-Case

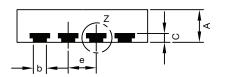
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?69822.

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Vishay Siliconix

PowerPAK[®] ChipFET[®] Case Outline

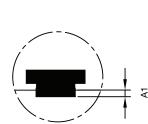




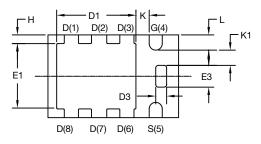


Side view of dual

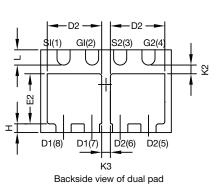
Side view of single



Detail Z



Backside view of single pad



DIM.	MILLIMETERS			INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.70	0.75	0.85	0.028	0.030	0.033		
A1	0	-	0.05	0	-	0.002		
b	0.25	0.30	0.35	0.010	0.012	0.014		
С	0.15	0.20	0.25	0.006	0.008	0.010		
D	2.92	3.00	3.08	0.115	0.118	0.121		
D1	1.75	1.87	2.00	0.069	0.074	0.079		
D2	1.07	1.20	1.32	0.042	0.047	0.052		
D3	0.20	0.25	0.30	0.008	0.010	0.012		
E	1.82	1.90	1.98	0.072	0.075	0.078		
E1	1.38	1.50	1.63	0.054	0.059	0.064		
E2	0.92	1.05	1.17	0.036	0.041	0.046		
E3	0.45	0.50	0.55	0.018	0.020	0.022		
е		0.65 BSC			0.026 BSC			
Н	0.15	0.20	0.25	0.006	0.008	0.010		
К	0.25	-	-	0.010	-	-		
K1	0.30	-	-	0.012	-	-		
K2	0.20	-	-	0.008	-	-		
K3	0.20	-	-	0.008	-	-		
L	0.30	0.35	0.40	0.012	0.014	0.016		
C14-0630-Rev. E DWG: 5940	, 21-Jul-14							

Note

• Millimeters will govern

Revision: 21-Jul-14

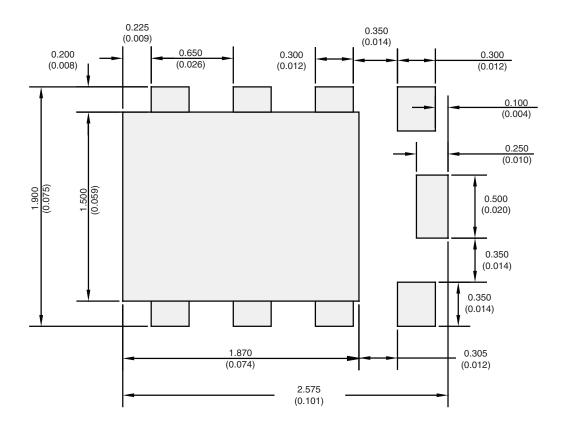
1 For technical questions, contact: <u>pmostechsupport@vishay.com</u>

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Application Note 826 Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK[®] ChipFET[®] Single



Recommended Minimum Pads Dimensions in mm/(Inches)

Return to Index

APPLICATION NOTE



Vishay

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